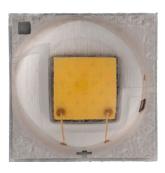
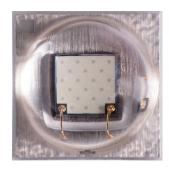
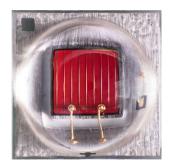


Cree[®] XLamp[®] XP-E2 LEDs







PRODUCT DESCRIPTION

The XLamp XP-E2 LED builds on the unprecedented performance of the original XP-E by increasing lumen output up to 20% while providing a single die LED point source for precise optical control. The XP-E2 LED shares the same footprint as the original XP-E, providing a seamless upgrade path to more lumens and/or greater efficiency while shortening the design cycle for existing XP customers.

XLamp XP-E2 LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED retrofit lamps, outdoor, portable, indoor directional, emergency vehicle or architectural.

FEATURES

- Available in white, outdoor white, 80-CRI, 85-CRI, 90-CRI white, royal blue, blue, green, amber, red-orange & red
- ANSI-compatible chromaticity bins
- White binned at 85 °C
- Maximum drive current: 1 A
- Low thermal resistance: as low as 5 °C/W
- Wide viewing angle: 110°-135°
- Unlimited floor life at
 ≤ 30 °C/85% RH
- Reflow solderable JEDEC
 J-STD-020C compatible
- Electrically neutral thermal path
- RoHS-compliant
- UL-recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		9	
Thermal resistance, junction to solder point - green	°C/W		15	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		110	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - amber, red-orange, red	degrees		130	
Temperature coefficient of voltage - white	mV/°C		-2.3	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-3.3	
Temperature coefficient of voltage - green	mV/°C		-3.8	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-1.8	
ESD withstand voltage (HBM per Mil-Std-883D)- white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - amber, red-orange, red			Class 2	
DC forward current	mA			1000
Reverse voltage	V			5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.25
Forward voltage (@ 700 mA, 85 °C) - white			3.05	
Forward voltage (@ 1000 mA, 85 °C) - white			3.15	
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.5
Forward voltage (@ 350 mA, 25 °C) - green	V		3.2	3.6
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.2	2.6
Forward voltage (@ 1000 mA, 25 °C) - royal blue, blue	V		3.4	
Forward voltage (@ 1000 mA, 25 °C) - green	V		3.7	
Forward voltage (@ 1000 mA, 25 °C) - amber, red-orange, red	V		2.65	
LED junction temperature	°C			150



FLUX CHARACTERISTICS (T₁ = 85 °C) - WHITE

The following table provides several base order codes for XLamp XP-E2 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family Binning and Labeling document.

Color	CCT Range		Base Order Codes CCT Range Min. Luminous Flux (Im) @ 350 mA		Luminous I	l Minimum Flux (lm)** 5 °C	Order Code	
	Min.	n. Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	
			Q4	100	116	171	218	XPEBWT-L1-0000-00C51
Cool White	5000 K	10 000 K	Q5	107	124	183	233	XPEBWT-L1-0000-00D51
Cool Wille	3000 K	10,000 K	R2	114	132	195	249	XPEBWT-L1-0000-00E51
			R3	122	142	209	266	XPEBWT-L1-0000-00F51
			Q4	100	116	171	218	XPEBWT-01-0000-00CC2
Outdoor	4000 K	5300 K	Q5	107	124	183	233	XPEBWT-01-0000-00DC2
White	4000 K	2300 K	R2	114	132	195	249	XPEBWT-01-0000-00EC2
			R3	122	142	209	266	XPEBWT-01-0000-00FC2
			Q4	100	116	171	218	XPEBWT-L1-0000-00CE4
Neutral White	3700 K	K 5300 K	Q5	107	124	183	233	XPEBWT-L1-0000-00DE4
			R2	114	132	195	249	XPEBWT-L1-0000-00EE4
80-CRI	2200 K	4300 K	Q2	87.4	101	150	191	XPEBWT-H1-0000-00AE7
White	2200 K	4300 K	Q3	93.9	109	161	205	XPEBWT-H1-0000-00BE7
			Q2	87.4	101	150	191	XPEBWT-L1-0000-00AE7
Warm White	2200 K	3700 K	Q3	93.9	109	161	205	XPEBWT-L1-0000-00BE7
			Q4	100	116	171	218	XPEBWT-L1-0000-00CE7
			P2	67.2	78.0	115	147	XPEBWT-P1-0000-007E7
85-CRI	2600 16	2200 14	Р3	73.9	85.7	127	161	XPEBWT-P1-0000-008E7
White	2600 K	3200 K	P4	80.6	93.5	138	176	XPEBWT-P1-0000-009E7
			Q2	87.4	101	150	191	XPEBWT-P1-0000-00AE7
			P2	67.2	78.0	115	147	XPEBWT-U1-0000-007E7
90-CRI White	2600 K	3200 K	Р3	73.9	85.7	127	161	XPEBWT-U1-0000-008E7
			P4	80.6	93.5	138	176	XPEBWT-U1-0000-009E7

Notes:

- Cree maintains a tolerance of ± 7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements.
- Typical CRI for Cool White (5000 K 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2200 K 3700 K CCT) is 80.
- · Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 700 mA and 1 A are for reference only.



FLUX CHARACTERISTICS ($T_1 = 25$ °C) - COLOR

The following table provides several base order codes for XLamp XP-E2 color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family Binning and Labeling document.

	Minir Radiant 350	Flux @	Domi	nant Wav	elength F		
Color		Floor	Min.		Max.		Order Codes,
	Group	Flux (mW)	Group	DWL (nm)	Group	DWL (nm)	
	30	450	D3	450	D5	465	XPEBRY-L1-0000-00J01
	31	475	D3	450	D5	465	XPEBRY-L1-0000-00K01
Royal	32	500	D3	450	D5	465	XPEBRY-L1-0000-00L01
Blue	33	525	D3	450	D5	465	XPEBRY-L1-0000-00M01
	34	550	D3	450	D5	465	XPEBRY-L1-0000-00N01
	35	575	D3	450	D5	465	XPEBRY-L1-0000-00P01

	Domi	nant Wav	elength R	Range		Base Order Codes Min.										
Color	Min.		Max.		Luminous Flux (lm) @ 350 mA		Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)											
							B6 4							K2	30.6	XPEBBL-L1-0000-00Y01
Blue	В3	465	В6	B6	R6	R6		405	B6 485	К3	35.2	XPEBBL-L1-0000-00Z01				
blue	63	403		485	M2	39.8	XPEBBL-L1-0000-00201									
				М3	45.7	XPEBBL-L1-0000-00301										

	Domi	nant Wav	elength F	lange	Base Order Codes Min.			
Color	Min.		Max.		Luminous Flux (lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
				535	Q2	87.4	XPEBGR-L1-0000-00A01	
					Q3	93.9	XPEBGR-L1-0000-00B01	
Green	G2	520	G4		ESE	Q4	100	XPEBGR-L1-0000-00C01
Green	Green G2 520	320			Q5	107	XPEBGR-L1-0000-00D01	
					R2	114	XPEBGR-L1-0000-00E01	
					R3	122	XPEBGR-L1-0000-00F01	

Note: Cree maintains a tolerance of \pm 7% on flux and power measurements and \pm 1 nm on dominant wavelength measurements.



FLUX CHARACTERISTICS ($T_{j} = 25 \text{ °C}$) - COLOR (CONTINUED)

	Dominant Wavelength Range					Order 5 Min.								
Color	Min.		Max.		Luminous Flux (lm) @ 350 mA		Order Code							
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)								
												N4	62.0	XPEBAM-L1-0000-00601
Ambar	4.7	FOF	A3	42	Δ3	42 505	P2 67.2 XPE	XPEBAM-L1-0000-00701						
Alliber	Amber A2 585 /	363		595	Р3	73.9	XPEBAM-L1-0000-00801							
			P4	80.6	XPEBAM-L1-0000-00901									

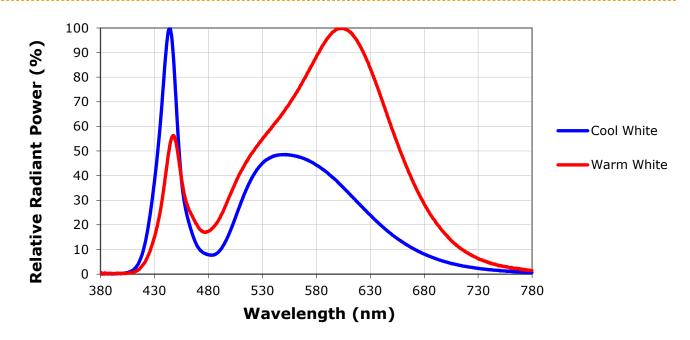
	Domi	nant Wav	elength R	lange	Base Order Codes Min.			
Color	Min.		Max.		Luminous Flux (lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
				620	P2	67.2	XPEBRO-L1-0000-00701	
	Red- O3 610 Orange				Р3	73.9	XPEBRO-L1-0000-00801	
Red-		610	04		P4	80.6	XPEBRO-L1-0000-00901	
Orange		010			Q2	87.4	XPEBRO-L1-0000-00A01	
					Q3	93.9	XPEBRO-L1-0000-00B01	
					Q4	100	XPEBRO-L1-0000-00C01	

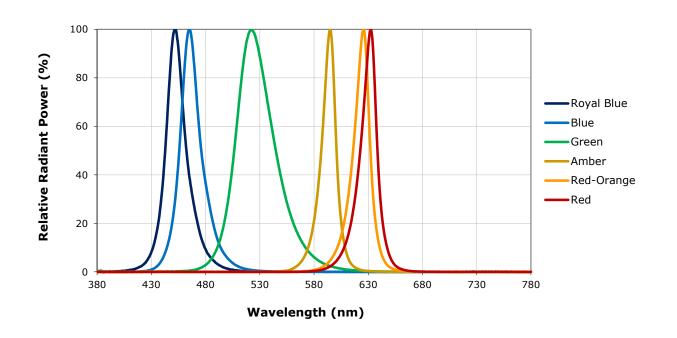
	Dominant Wavelength Range					Order 5 Min.										
Color	Min.		Max.		Luminous Flux (lm) @ 350 mA		Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)										
														N3	56.8	XPEBRD-L1-0000-00501
Red	R2	620	R3	DЗ	DЗ	630	N4	62.0	XPEBRD-L1-0000-00601							
Red	K2	020		030	P2	67.2	XPEBRD-L1-0000-00701									
			Р3	73.9	XPEBRD-L1-0000-00801											

Note: Cree maintains a tolerance of \pm 7% on flux and power measurements and \pm 1 nm on dominant wavelength measurements.



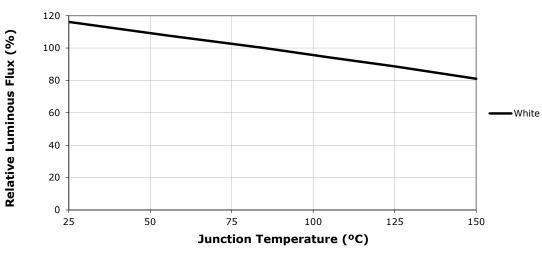
RELATIVE SPECTRAL POWER DISTRIBUTION

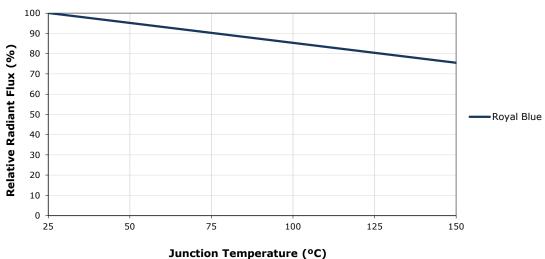


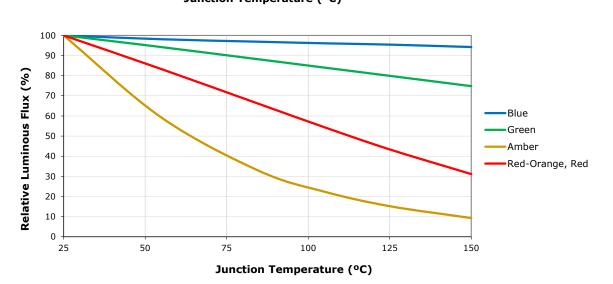




RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)

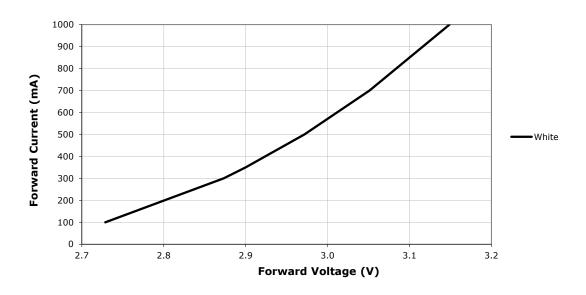




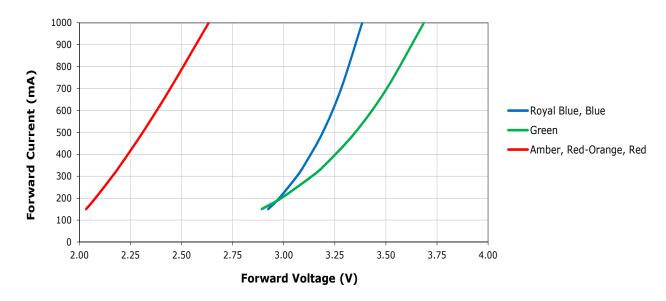




ELECTRICAL CHARACTERISTICS (T₁ = 85 °C)

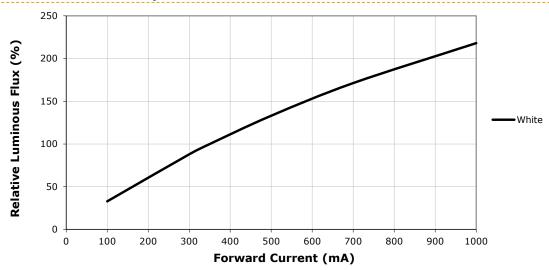


ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)

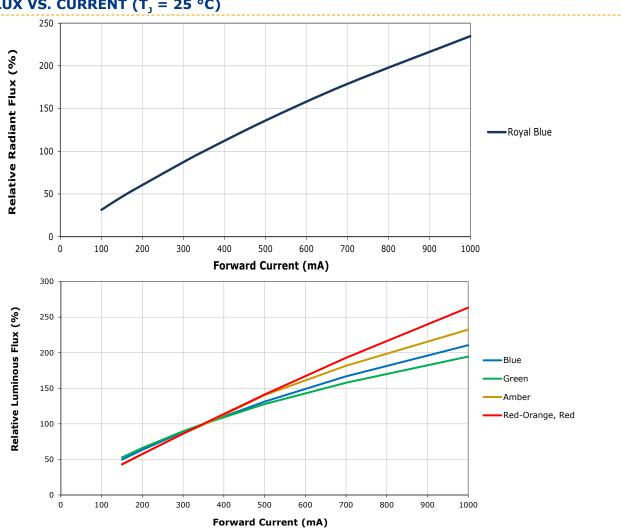




RELATIVE FLUX VS. CURRENT ($T_{_{\rm J}}$ = 85 °C)

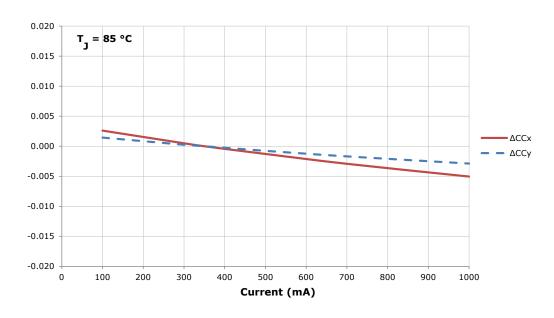


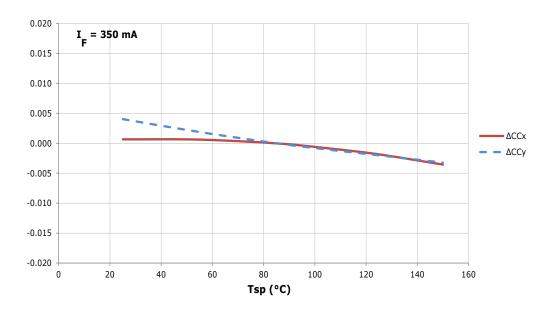
RELATIVE FLUX VS. CURRENT ($T_1 = 25$ °C)





RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE - WARM WHITE*

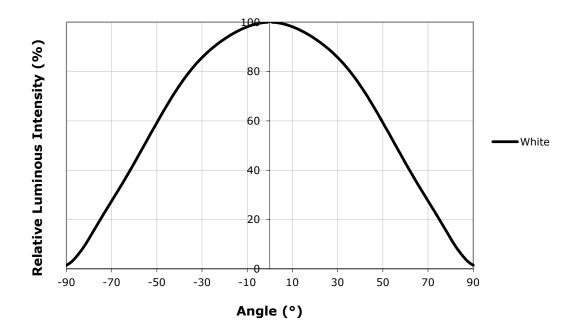


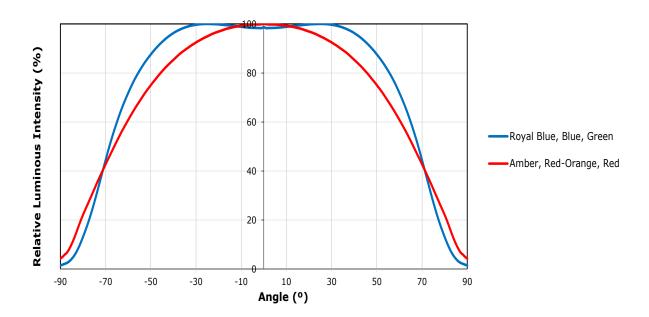


^{*} Warm White XLamp XP-E2 LEDs have a typical CRI of 80.



TYPICAL SPATIAL DISTRIBUTION

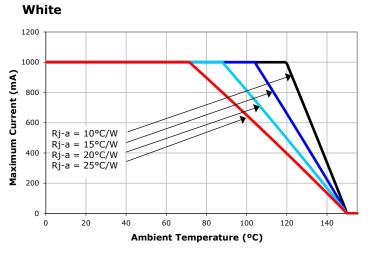


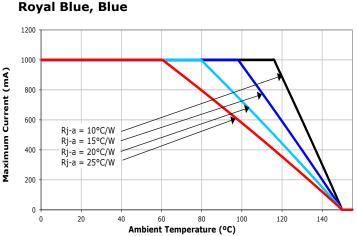


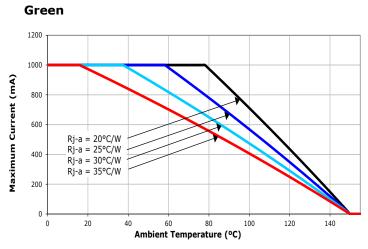


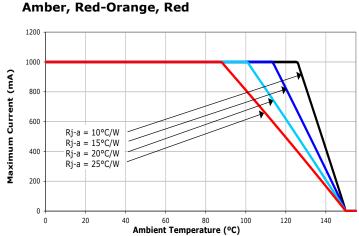
THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.







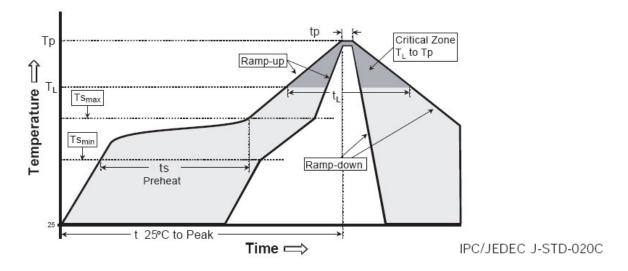




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-E2 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T _L)	183 °C	217 °C
Time Maintained Above: Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

In testing, Cree has found XLamp XP-E2 LEDs to have unlimited floor life in conditions \leq 30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDS to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

UL Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

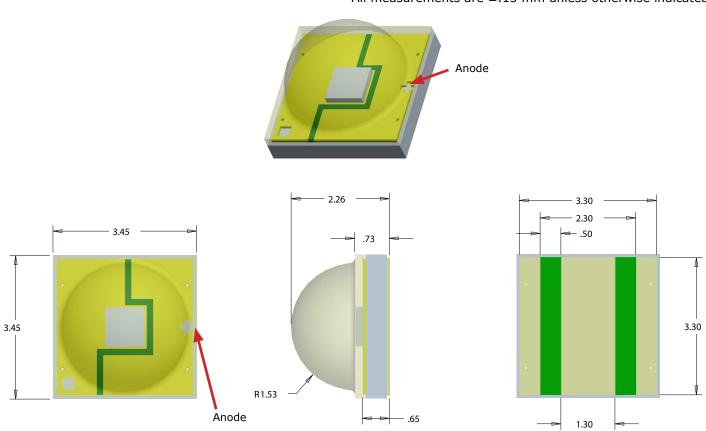
Vision Advisory Claim

WARNING: Do not look at exposed lamp in operation. Eye injury can result. See LED Eye Safety at www.cree.com/xlamp_app_notes/led_eye_safety.



MECHANICAL DIMENSIONS

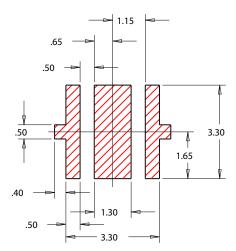
All measurements are $\pm .13$ mm unless otherwise indicated.



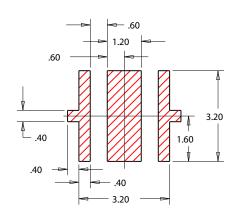
Top View

Side View

Bottom View



Recommended PCB Solder Pad

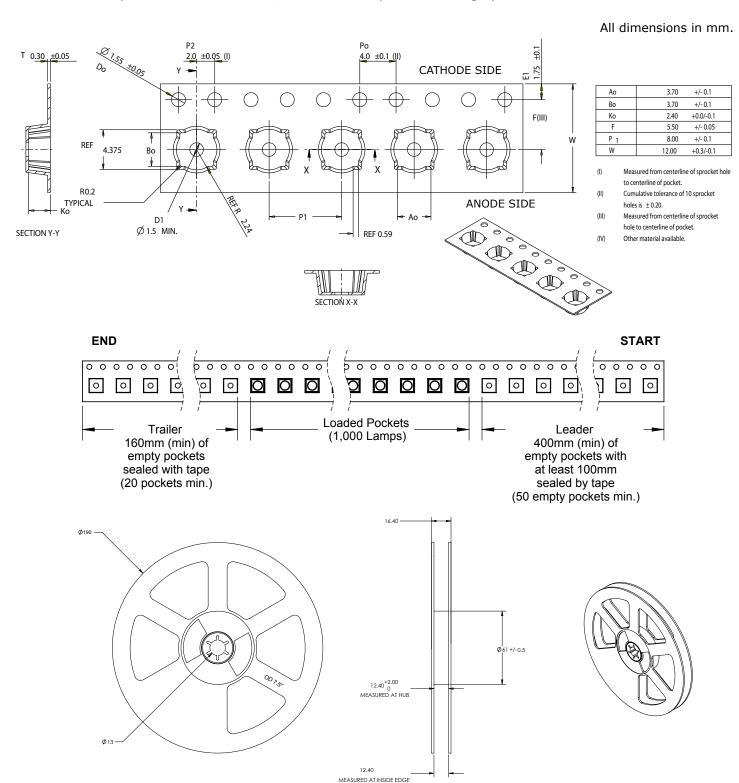


Recommended Stencil Pattern Hatched Area is Opening



TAPE AND REEL

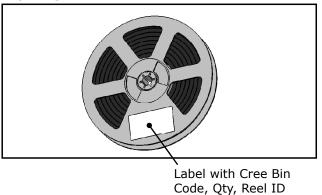
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.





PACKAGING

Unpackaged Reel



Packaged Reel

